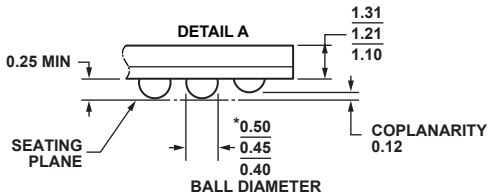
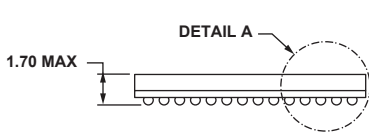
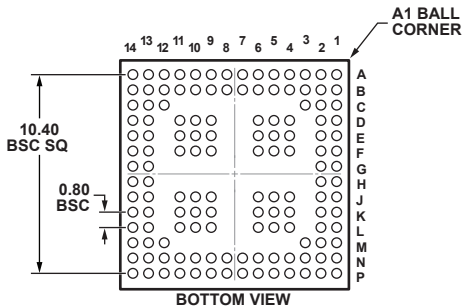
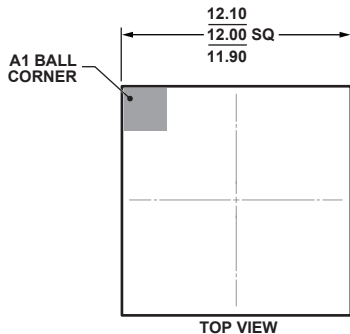


136-Ball Chip Scale Package Ball Grid Array [CSP_BGA] (BC-136-1)

Dimensions shown in millimeters



***COMPLIANT WITH JEDEC STANDARDS MO-275-GGAA-1
WITH EXCEPTION TO BALL DIAMETER.**